Sustainable Electronics – The Canary in the Coal Mine for Planet Earth

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Purdue University Materials Engineering Environmental & Ecological Engineering

Purdue – Mexico Workshop on Sustainability 29-30 April 2013

Purdue – Partnership. Creativity, and Impact

Pb-Free and Next Generation Electronics

- Tin whiskers John Blendell
 - Wei-Hsun Chen, Nick Clore, John Koppes, Aaron Pedigo,
 Pylin Sarobol, Ying Wang
- Pb-free solders Ganesh Subbarayan (ME) and Mysore Dayananda
 - Santosh Kumar, Jon Tucker, John Holaday, and Yuvraj Singh
- Nanoparticle-enabled electronics and solar cells-Eric Stach, Elliott Slamovich and Rakesh Agrawal (ChE)
 - Milea Kammer, Suk Jun Kim, Tony Muza, Luthfia Syarbaini, Yan Guo, Ruihong Zhang

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Sustainable Electronics

- Anthropology: Kory Cooper, Riall Nolan
- Chemistry: Jon Wilker
- Forestry and Natural Resources: Marisol Sepulveda
- Management: Ananth Iyer, Susan Watts
- Political Science: Leigh Raymond
- Engineering: Agricultural/Biological Bernie Tao, Civil – Inez Hua, Education – Monica Cox, Electrical/Computer – Dimitri Peroulis, Environmental/Ecological – John Sutherland, Materials – Carol Handwerker, John Howarter, Robert Moon, Jeffrey Youngblood, Mechanical – Karthik Ramani, Fu Zhao

Purdue – Partnership. Creativity, and Impact **Sustainable Electronics** In close collaboration with Tuskegee University Materials Science & Engineering Ph.D. program faculty

- Mahesh Hosur
- Melissa Reeves
- Michael Curry
- Vijaya Rangari
- Tamara Floyd-Smith



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Sustainable Electronics

- Recycling LCD TVs: Fu Zhao and Kory Cooper
 - 18 undergraduates from MSE, ME, Communications, and Anthropology (2009-2012)- Electronic TakeBack Coalition
 - Current: 5 EEE undergraduates EPA P3 project (Zhao PI)
- NSF IGERT: Global Traineeship in Sustainable Electronics: Inez Hua, Ananth Iyer, Karthik Ramani, Mahesh Hosur (Tuskegee)
- DOE Critical Materials Institute: Ananth Iyer, John Sutherland, and Fu Zhao
 - DOE Energy Innovation Hub starting April 2013, with Ames







"Sustainable development is development that meets the needs of the present without compromising the ability of future generations to meet their own needs.

It contains within it two key concepts:

- the concept of **needs**, in particular the essential needs of the world's poor, to which overriding priority should be given; and
- the idea of **limitations** imposed by the state of technology and social organization on the environment's ability to meet present and future needs."

UN World Commission on Environment and Development (WCED). *Our common future*. Oxford: Oxford University Press, 1987 p. 43.





 Definition of global sustainability for electronics Are there guiding principles? How do we realistically measure what happens? How do we frame the right questions? What are the tradeoffs? What data are not there? How do we apply this at the research stage?

- We don't know what this looks like yet.
- We want to understand.
- We want to eliminate barriers.
- We want to build bridges to industry, NGO's, government, educators.



Sustainability

- Sustainable development:
 - meeting the needs of the present without compromising the ability of future generations to meet their own needs
- Economic Societal Environmental
- Sustainable for whom?
- Sustainable over what time?
- (Impact) X (number of people)
 RDUE

1.6B global 3G subscribers 6B mobile subscriptions worldwide in 2011 – *78/100* people in developing countries Total population of 6.9B

Simplified Supply Chain Map for an OEM

PURDUE UNIVERSITY.

http://greeningit.wordpress.com/2011/08/09/electronic-industrycitizenship-coalition-pilots-carbon-reporting-system/

Environmental impact = population * (impact per person)

Impact to have needs met Food Shelter Water Safety Community

Four Factors Determine the Amount of CO₂ Emissions

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Fig. 2. Impact chain in environmental performance assessment. CFC: chlorofluorocarbons; VOC: volatile organic compounds; HAP: hazardous air pollutants

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Sustainable Electronic Product Design: A Comparison of Environmental Performance Assessment Tools Derived from Life Cycle Thinking, **Xiaoying Zhou, Julie M. Schoenung**, *University of California – Davis, USA*, in: Web-Based Green Products Life Cycle Management Systems: Reverse Supply Chain Utilization, Ed. Hsiao-Fan Wang, IGI Global, 2009.

http://www.likecool.com/cate-Gear-256.html

TABLE II. WEIGHT VERSUS VALUE DISTRIBUTION

					Ag	Au	Pd
weight-%	Fe	AI	Cu	plastics	[ppm]	[ppm]	[ppm]
TV-board	28%	10%	10%	28%	280	20	10
PC-board	7%	5%	20%	23%	1000	250	110
mobile phone	5%	1%	13%	. 6.10	1380	350	210
portable audio	23%	1%	21%		150	10	4
DVD-player	62%	2%	5%	24%	115	15	4
calculator	4%	5%	3%	61%	260	50	5
value-share	Fe	AI	Cu	sum PM	Ag	Au	Pd
TV-board	4%	11%	42%	43%	8%	27%	8%
PC-board	0%	1%	14%	85%	5%	65%	15%
		. / .		0070	•		
mobile phone	0%	0%	7%	93%	5%	67%	21%
mobile phone portable audio	0% 3%	0% 1%	7% 77%	93% 20%	5% 4%	67% 13%	21% 3%
mobile phone portable audio DVD-player	0% 3% 13%	0% 1% 4%	7% 77% 36%	93% 20% 48%	5% 4% 5%	67% 13% 37%	21% 3% 5%

Improving metal returns and eco-efficiency in electronics recycling

- a holistic approach for interface optimisation between pre-processing and integrated metals smelting and refining

Sum of Precious Metals

Christian Hagelüken

Gold Wire Bonding

Environmental Impact – It is not how much is in the final product

WEEE Recast - Huisman and Magalini NVMP – StEP Summerschool on WEEE Philips HTC 2009-09-10

Energy Return on Investment

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Dennis Meadows:

Main Points of His Speech

- Growth has continued until we are now past sustainable levels.
- The global society will change more over the next 20 years than in the past 100. Design policies for what is coming, not what has been.
- The main forces for change will be climate change and resource scarcity especially fossil fuels and water.
- The end of growth does not result from total depletion, but from rising capital costs.
- The most important scarcity is the absence of a longer-term perspective.
 Economics and Limits to

Economics and Limits to Growth: What's Sustainable? Dennis Meadows

Washington, DC October 6, 2009

iNEMI

(International Electronics Manufacturing Initiative) An industry-led research and development consortium of 100+ major electronic firms, suppliers, industry associations and consortia, government agencies and universities.

- **roadmaps** the needs of the global electronics industry, identifies gaps in the technology infrastructure, and establishes implementation projects to eliminate these gaps (both business and technical).
- works with government, universities and funding agencies to **set priorities for R&D initiatives**.

• has been instrumental in providing the reliability and manufacturing knowledge necessary for the world-wide conversion to Pb-free electronics and continues to serve that role as replacement materials for electronics systems continue to be required due to environmental or human health bans or material shortages.

Sustainable Electronics – 2012 EPA & 2013 iNEMI Roadmaps

- Business decisions are aligned with sustainability objectives
- All life cycle costs are internalized in the products "Externalities are impacts generated by one economic actor, which are felt by others, but the market doesn't bring these impacts back to affect the actor that originated them. "Neva Goodwin
- Decisions are transparent
- Companies, consumers, and all people in the supply chain are accountable
- ICT enables smarter use of natural resources

Sustainable Electronics – 2012 EPA & 2013 iNEMI Roadmaps

- All ICT hardware is manufactured in facilities with best-in-class health, safety, and environmental standards globally with employees earning a living wage, no forced labor, no forced overtime, no child labor, no discrimination, and workers have freedom of association
- No chemical or materials selection is made without an alternatives assessment, or the substance is on the "good" list
- Hazardous emissions to air, water, land are eliminated
- Resources are not wasted
- People and communities benefit

Purdue University and Tuskegee University in close collaboration with the global electronics industry - iNEMI plus 5 corporate members - and

International Academic Partners - Fraunhofer IZM - Berlin, Shanghai Jiao Tong University, Tsinghua University – Beijing, Indian Institute of Management – Udaipur, Universidad EAFIT – Medellin

Vision

Create a new integrative, collaborative model for graduate research and education needed to enable *meaningful and measurable improvements in the global sustainability of electronics.*

Funded by NSF in June 2012

\$3.2M for 28 two-year fellowships over 5 years

External Advisory Board and opportunities for collaboration with industry, NGOs, research institutions

Advancing manufacturing technology

Three Research Thrusts

- 1. Polymers from Nature for Construction & Disassembly
 - Natural Nanocomposites for Structural Applications in Casings and Boards,
 - Bio-based Lignin and Soy-based Resins for Circuit Board Construction
 - Biomimetic Marine-Derived Bioadhesives for Device Construction & Disassembly
 - Green Replacements for Brominated Flame Retardants
- 2. Sustainable Product Design and Manufacturing
 - Novel LCA Approach for Electronic Products
 - Electronic Product Manufacturing Process Characterization and Improvement
 - LCA-based Design of Electronics
 - Recycling and Reuse of Electronic Devices
- 3. System and Supply Chain Issues
 - Integrating Sustainability Indicators across the Supply Chain
 - Corporate Sustainability Behavior Stakeholder Perception Corporate Valuation
 - Consumer Behavior
 - System-wide Effects of Laws and Regulations

IGERT will creates a Ph.D. graduate education and research traineeship to:

(4) Develop a curriculum with our industry and international university partners in Germany, Colombia, India, and China and disseminate it widely through Purdue's globalHUB cyberinfrastructure to positively influence the global stakeholders who impact electronics sustainability.

Advancing manufacturing technology

- Sara Beasley Leigh Raymond
- Bill Bernstein* Karthik Ramani
- Alexandra Bruce John Howarter, Inez Hua
- Kristy Crews Michael Curry (T), Robert Moon
- Michael Laird Johnston Jon Wilker, John Blendell
- Milea Kammer Carol Handwerker, Fu Zhao
- Mike McCoy Karthik Ramani
- Gamini Mendis John Howarter, Jeffrey Youngblood, Inez Hua
- Shane Peng Jeffrey Youngblood, Robert Moon
- Vertonica Powell-Rose Mahesh Hosur (T)
- Devarajan Ramanujan* Karthik Ramani
- Eldon Trigg Mahesh Hosur (T)
- Aditya Vendantum* Ananth Iyer

*IGERT Associates

Purdue – Partnership. Creativity, and Impact

Pb-Free Electronics

- Waste shipped to China and developing countries
 - Concentrates recycled electronics in countries with weakest recycling and environmental regulations
- Ultimately may reduce Pb-poisioning during informal recycling but not yet
- Tin whiskers are reliability problem
- Pb-free electronics are less impact-resistant
 - Higher processing temperatures
 - Circuit boards are more brittle
 - Stronger solder leads to more damage to the board
- More Sn mined Conflict mineral
- More Ag mined

Anthropology: Materials Development

Ashby, Shercliff, Cebon Materials – Engineering, Science, Processing, and Design, 2010

IRDUE RSIT Y. E

Journal of Archaeological Science (2000) 27, 771-778 doi:10.1006/jasc.1999.0580, available online at http://www.idealibrary.com on IDELL®

An Imperial Legacy? An Exploration of the Environmental Impact of Ancient Metal Mining and Smelting in Southern Jordan

F. B. Pyatt*

Extensive wastes from the copper mining and smelting activities of the Nabatean, Roman and Byzantine periods in the Wadi Faynan in the southern Jordanian desert continue to exert a profound influence upon the environment, mainly through processes of bioaccumulation. It is suggested that in antiquity both producers and consumers (plants and animals) would have similarly been subjected to enhanced bioaccumulation of potentially toxic heavy metals such as lead and copper, whose consequences are explored in this account. © 2000 Academic Press

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S. McLaren

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Department of Geography, University

(Gilbertson *et al.*, 1997). Small wonder then that in Romano-Byzantine times the mines of Phaino were Department of Geographical and Env seen as a place to send recalcitrant criminals. Eusebius of Caesarea in his "Martyrs of Palestine" describes such a scene; "they demanded that he should be sent away to the mines, and not just any mines but to that of Phaino where even a condemned murderer is hardly able to live a few days".

- How innovative are we prepared to be?
- How resilient are we to change?

ONE DECISION AN ENGINEER

MAKES CAN HAVE MORE

ON THE ENVIRONMENT THAN A LIFETIME OF RECYCLING

ENVIRONMENTAL AND ECOLOGICAL ENGINEERING

Richard Heinberg Post Carbon Institute - September 2009

Antimony	China	Thermoelectric/paraelectric materials
Barium	China	Thermoelectric/paraelectric materials
Bismuth	China, Mexico	Thermoelectric/paraelectric materials
Cobalt	Kinshasa, Australia	Photovoltaics
Gallium	China	Photovoltaics
Germanium	Belgium, Canada	Photovoltaics
Indium	China, Canada	Photovoltaics, thermo/paraelectric mat'ls
Manganese	Gabon, S. Africa	Photovoltaics
Nickel	Canada	Fuel cells
Platinum	S. Africa	Fuel cells, thermoelectric materials
Rare Earths	China	Fuel cells, magnets, thermoelectric materials
Tellurium	Belgium, Germany	Solar cells, semiconductors
Titanium	Australia, S. Africa	Solar cells
Zinc	Canada, Mexico	Photovoltaics, fuel cells

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Indium Depletion

• Deposits of tin and tungsten have the highest known concentrations of Indium (Tolcin)

• By 2040 all currently known Indium deposits will have been mined (Roper)

Roper, David L. Indium Depletion Including Recycling. http://arts.bev.net/RoperLDavid/20 March, 2010 Tolcin, Amy C. USGS Mineral Resources Program. 2011. http://minerals.usgs.gov/minerals/pubs/commodity/indium/mcs-2008-indiu.pdf

Energy Analysis for a Coffeemaker

Materials

Environment

Eco-Informed Material Choice

B

Table 7.6 Coffee maker142 bill of materials, life: five years						
Component	Material	Process	Mass, kg	Material energy, MJ/kg*	Process energy, MJ/kg*	
Housing	Polypropylene	Polymer molding	0.91	94	8.6	Michael F. Ashby
Small steel parts	Steel	Def. processing	0.12	81	3.4	1. 2000 - 772 - XXX VIII / 2007 - 772 - 77
Small aluminum parts	Aluminum	Def. processing	0.08	210	2.6	
Glass jug	Glass (Pyrex)	Molded	0.33	25	8.2	
Heating element	Ni-Cr alloy	Def. processing	0.026	130	2.6	
Electronics and LED	Electronics	Assembled	0.007	3000	130	
Cable sheath, 1 meter	PVC	Polymer extrusion	0.12	66	7.6	
Cable core, 1 meter	Copper	Def. processing	0.035	71	2.0	
Plug body	Phenolic	Polymer molding	0.037	90	13	
Plug pins	Brass	Def. processing	0.03	72	2.3	
Packaging, padding	Polymer foam	Polymer molding	0.015	110	11	
Packaging, box	Cardboard	Construction	0.125	28	0.5	
Other components	<i>Proxy material:</i> Polycarbonate	<i>Proxy process:</i> Polymer molding	0.04	110	11	
		Total mass	1.9			

*From the data sheets of Chapter 12 and Table 6.4.

Material Recycling at Product End-of-Life

"However, while recycling technologies may improve, design trends seem to be pushing products towards lower material value and greater material mixing. Designers are constantly motivated to reduce material costs in products, either by using less material or by using less expensive materials. At the same time, materials are being used in new and different applications, presenting designers with increasingly wider selections of potential materials."

FIGURE 4. A plot of single product recycled material values ($\sum m_i k_i$), material mixing (*H*), and recycling rates (indicated by the area of the circles) for 20 products in the U.S. The "apparent recycling boundary" is shown.

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Material Recycling at Product End-of-Life

Jeffrev B. Dahmus and Timothv G. Gutowski ENVIRONMENTAL SCIENCE & TECHNOLOGY / VOL. 41, NO. 21, 2007

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Polymeric Materials Used in Electronic Packaging

Adhesive

Acrylic, Epoxy silicone, Epoxy novalac, Epoxy bisphenol A, Epoxy polyimide, Epoxy polyurethane, Polyimide, Silicones

Encapsulation

Polyetherketone, Polyetheretherketone, Polysulfone, Polyethersulfone, Polyester Epoxy and filled epoxy Silicones and filled silicones

Substrate

Bis-maleimide triazine (BT) resin, BT-Epoxy E-glass laminate, Epoxy-E-glass laminate, Polyimide-E-glass laminate, Poly(tetrafluoroethylene)-E-glass laminate, Polyimide-Eglass laminate, Polyester film, Polyimide film, Poly(tetrafluoroethylene) film, Polyamide film, Poly(vinyl chloride) film, Poly(vinyl fluoride) film, Polyethylene film, Polypropylene film, Polycarbonate film, Polysulfone film, Poly(parabanic acid) film, Poly(ethersulfone) film

Stress buffer coating

Poly(amide-imide), Poly(benzocyclobutene)-BCB, Polybenzoxazole, PolyimideRTV Silicone

Interlayer dielectric

Poly(benzocyclobutene)–BCB, Polybenzoxazole, Polyimide, Poly(norbornene), Triazine blend resin

PURDUE com/doc/101919564/Electronic-Packaging

NNI – Face of US Nanotechnology

"The vision of the NNI is a future in which the ability to understand and control matter at the nanoscale leads to a revolution in technology and industry that benefits society.

The NNI expedites the discovery, development, and deployment of nanoscale science, engineering, and technology to serve the public good, through a program of coordinated research and development aligned with the missions of the participating agencies."

From 2011 National Nanotechnology Initiative Strategic Plan

THE NATIO

Definitions of NNI Success THE NATIONAL

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- Frontiers of knowledge are being substantially advanced, commensurate with the scale of funding.
- An appropriate, world-class scientific and technical workforce is being trained and educated in the US.
- Vibrant, competitive and sustainable industry sectors evolve in the USA that use nanotechnology to enable the creation of new products, skilled employment and economic growth.
- NNI infrastructure meets the users' needs.
- Businesses of all sizes are aware of potential risks of nanomaterials and know where to obtain current information about properties and best practices for handling them.